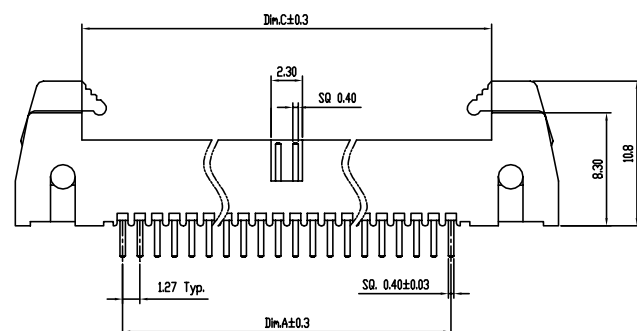
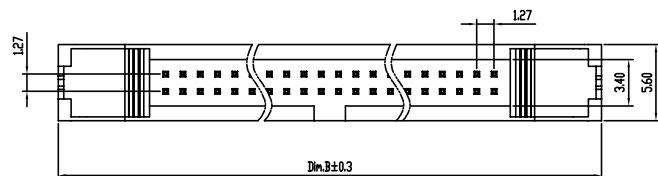
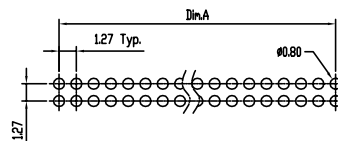


TABLE 1

DASH No.	Dim. of Pin	Dim.A	Dim.B	Dim.C
-000 06 XX LF	6	2.54	18.31	8.46
-000 10 XX LF	10	5.08	20.85	11.00
-000 12 XX LF	12	6.35	22.12	12.27
-000 14 XX LF	14	7.62	23.39	13.54
-000 16 XX LF	16	8.89	24.66	14.81
-000 20 XX LF	20	11.43	27.20	17.35
-000 26 XX LF	26	15.24	31.01	21.16
-000 30 XX LF	30	17.78	33.55	23.70
-000 34 XX LF	34	20.32	36.09	26.24
-000 40 XX LF	40	24.13	39.90	30.05
-000 44 XX LF	44	26.67	42.44	32.59
-000 50 XX LF	50	30.48	46.25	36.40
-000 60 XX LF	60	36.83	52.60	42.75
-000 64 XX LF	64	39.37	55.14	45.29
-000 66 XX LF	66	40.64	56.41	46.56
-000 68 XX LF	68	41.91	57.68	47.83



Recommended P.C.B. Layout (2)
Layout Tolerance = ± 0.05 mm

NOTE:

- MATERIAL,
HOUSING: HIGH TEMP PLASTIC, UL94-V0, BLACK
TERMINAL: COPPER ALLOY, SQ=0.40 $\pm$ 0.03MM
- FINISH:
TERMINAL: GOLD AT CONTACT,
G/F OVER 1um(40u") MIN Ni OVER ALL
- SPEC.:
PRODUCT SPEC: GS-12-629
PACKING SPEC: GS-14-1420
- THE HSG. WILL WITHSTAND EXPOSURE TO 260C
PEAK TEMP. FOR 10 SEC. IN A WAVE SOLDER APPLICATION
WITH A PCB.
- PRODUCT NUMBERING:
20021611 - 0 0 0 XX X X LF

LEAD FREE

PLATING:

1:GOLD FLASH ALL OVER

4:0.25um(10U")GOLD AT CONTACT

8:0.76um(30U")GOLD AT CONTACT

9:1u" GOLD OVER 30u" PdNi AT CONTACT

PACKING

T: TUBE

PIN COUNT
SEE TABLE 1

mat'l. code		surface		tolerance		projection		product family	
ISO1302		ISO1101		ISO406		MM		MINITEK	
l t r e c n n o d r		date		tolerances unless otherwise specified		title		1.27X1.27MM BTB EJECT HEADER	
A	T09-1117	S.LIN	09/15/09	angle	0.X $\pm$ 0.38	MM		VERTICAL TH	
B	T10-0025	S.LIN	01/20/10	0'±2'	0.XX $\pm$ 0.25	scale 2:1		dwg no	
C	EX-N-010365	ZK	01/16/12	0'±2'	0.XXX $\pm$ 0.10	sheet 1 of 1		size	
dr		STERLING LIN		09/15/09		FCI		20021611	
engr		STERLING LIN		09/15/09		type		Product Customer Drawing	
chr		GRAY HSIEH		09/15/09		sheet index		revision	
appd		JOSEPH		09/15/09		sheet 1		revision 1	